

ISL1571

Power Line Communication (PLC)

The [ISL1571](#) is a dual operational amplifier designed for PLC line driving in Orthogonal Frequency-Division Multiplexing (OFDM) and Spread Spectrum Communication (SSC) based solutions. This device features a high drive capability of 750mA while consuming only 6mA of supply current per amplifier and operating from a single 4.5V to 12V supply. The driver achieves a typical distortion of -80dBc, at 150kHz into a 25Ω load.

The ISL1571 is available in the thermally-enhanced 16 Ld QFN or 10 Ld HMSOP package and is specified for operation across the full -40°C to +85°C temperature range. The ISL1571 has control pins BIAS₀ and BIAS₁ for controlling the bias and enable/disable of the outputs. These controls allow for lowering the power to fit the performance/power ratio for the application.

The ISL1571 is ideal for line driving applications following the Homeplug 1.0, Homeplug AV and UPA standard based PLC.

Applications

- Homeplug 1.0
- Homeplug AV
- UPA digital home standard

Features

- 21dBm output power capability
- Drives up to 750mA from a +12V supply
- 20V_{P-P} differential output drive into 21Ω
- Very low noise floor
- -75dBc typical driver output distortion at 4MHz
- -80dBc typical driver output distortion at 10MHz
- -79dBc typical driver output distortion at 17MHz
- Low quiescent current of 6mA per amplifier
- Supply range
 - ISL1571IUEZ: 4.5V to 12V
 - ISL1571IRZ ±2.25V to ±6V: 4.5V to 12V
- 250MHz bandwidth
- Thermal shutdown
- Pb-free (RoHS compliant)

Related Literature

For a full list of related documents, visit our website:

- [ISL1571](#) device page

1. Overview

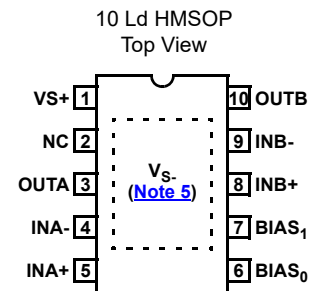
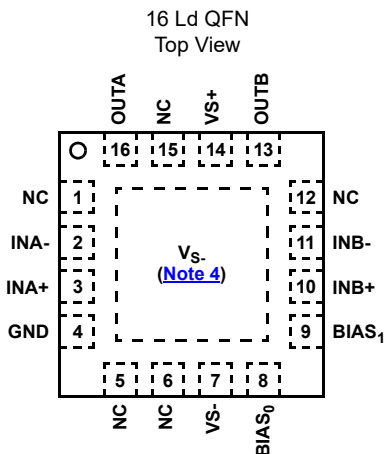
1.1 Ordering Information

Part Number (Notes 2, 3)	Part Marking	Temp. Range (°C)	Tape and Reel (Units) (Note 1)	Package (RoHS Compliant)	Pkg. Dwg. #
ISL1571IRZ	157 1IRZ	-40 to +85	-	16 Ld QFN	L16.4x4H
ISL1571IRZ-T7	157 1IRZ	-40 to +85	1k	16 Ld QFN	L16.4x4H
ISL1571IUEZ	BBBDA	-40 to +85	-	10 Ld HMSOP	M10.118B
ISL1571IUEZ-T7	BBBDA	-40 to +85	1.5k	10 Ld HMSOP	M10.118B

Notes:

1. See [TB347](#) for details on reel specifications.
2. These Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J-STD-020.
3. For Moisture Sensitivity Level (MSL), see the [ISL1571](#) device page. For more information about MSL, see [TB363](#).

1.2 Pin Configuration



Note:

4. Thermal pad must be connected to negative supply: V_{S-} . QFN package can be used in single and dual supply applications.

Note:

5. Thermal pad must be connected to negative supply: V_{S-} . HMSOP package can be used in single supply applications only.

1.3 Pin Descriptions

16 Ld QFN	10 Ld HMSOP	Pin Name	Function
1, 5, 6, 12, 15	2	NC	No Connect
2	4	INA-	Inverting Input of Amplifier A
3	5	INA+	Non-Inverting Input of Amplifier A
4	Thermal Pad	GND	Ground Connect
7	Thermal Pad	VS-	Negative Supply
8	6	BIAS ₀ (Note 6)	Current Control Bias Pin
9	7	BIAS ₁ (Note 6)	Current Control Bias Pin
10	8	INB+	Non-Inverting Input of Amplifier B
11	9	INB-	Inverting Input of Amplifier B
13	10	OUTB	Output of Amplifier B
14	1	VS+	Positive Supply
16	3	OUTA	Output of Amplifier A

Note:

6. The single DSL port is comprised of amplifiers A and B. BIAS₀ and BIAS₁ control the I_S settings for the DSL port.

2. Specifications

2.1 Absolute Maximum Ratings

Parameter	Minimum	Maximum	Unit
V _{S+} Voltage to Ground	-0.3	+13.2	V
V _{IN+} Voltage	GND	V _{S+}	
Current into any Input		8	mA
Continuous Output Current		75	mA
BIAS ₀ , BIAS ₁ to Ground		+6.6	V
ESD Rating	Value		Unit
Human Body Model (Note 7)	1		kV
Charge Device Model	1.5		kV

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions can adversely impact product reliability and result in failures not covered by warranty.

Note:

7. Excludes C0 and C1 pins which show less than 1kV of HBM ESD sensitivity.

2.2 Thermal Information

Parameter	Minimum	Maximum	Unit
Ambient Operating Temperature Range	-40	+85	°C
Storage Temperature Range	-60	+150	°C
Operating Junction Temperature		+150	°C
Power Dissipation			See Curves
Pb-Free Reflow Profile	see TB493		

2.3 Electrical Specifications

V_S = 12V, R_F = 750Ω, R_{L-DIFF} = 50Ω, BIAS₀ = BIAS₁ = 0V, T_A = +25°C, unless otherwise specified.

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
AC Performance						
-3dB Bandwidth	BW	R _F = 750Ω, A _V = +5		250		MHz
		R _F = 750Ω, A _V = +10		200		MHz
Total Harmonic Distortion, Differential	THD	f = 4MHz, V _O = 4V _{P-P-DIFF} , R _{L-DIFF} = 100Ω		-75		dBc
		f = 10MHz, V _O = 4V _{P-P-DIFF} , R _{L-DIFF} = 100Ω		-80		dBc
		f = 17MHz, V _O = 4V _{P-P-DIFF} , R _{L-DIFF} = 100Ω		-79		dBc
Slew Rate, Single-ended	SR	V _{OUT} from -3V to +3V	750	1200		V/μs
DC Performance						
Offset Voltage Common Mode	V _{OS_CM}		-40		+40	mV
Offset Voltage Differential Mode	V _{OS_DM}		-7.5		+7.5	mV
Differential Transimpedance	R _{OL}	V _{OUT} = 12V _{P-P} differential, unloaded		3.0		MΩ
Input Characteristics						
Non-Inverting Input Bias Current	I _{B+}		-7.0		+7.0	μA
Inverting Input Bias Current Differential Mode	I _{B-DM}		-75	3	+75	μA
Input Noise Voltage	e _N			6		nV√Hz

$V_S = 12V$, $R_F = 750\Omega$, $R_{L-DIFF} = 50\Omega$, $BIAS_0 = BIAS_1 = 0V$, $T_A = +25^\circ C$, unless otherwise specified. (Continued)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
-Input Noise Current	i_N			13		$\mu A/\sqrt{Hz}$
Output Characteristics						
Loaded Output Swing (single ended)	V_{OUT}	$V_S = \pm 6V$, $R_{L-DIFF} = 50\Omega$	± 4.8	± 5.0		V
		$V_S = \pm 6V$, $R_{L-DIFF} = 20\Omega$	± 4.35	± 4.7		V
Output Current	I_{OUT}	$R_L = 0\Omega$		1000		mA
Supply						
Supply Voltage	V_S	Single supply	4.5		13.2	V
Positive Supply Current per Amplifier	I_{S+} (Full Bias)	$V_S = 4.5V$, no load, $BIAS_0 = BIAS_1 = 0V$	12	15	21.5	mA
	I_{S+} (Medium Bias)	$V_S = 4.5V$, no load, $BIAS_0 = 5V$, $BIAS_1 = 0V$		11		mA
	I_{S+} (Low Bias)	$V_S = 4.5V$, no load, $BIAS_0 = 0V$, $BIAS_1 = 5V$		6.0		mA
	I_{S+} (Power-down)	$V_S = 4.5V$, no load, $BIAS_0 = BIAS_1 = 5V$		0.6	1.0	mA
$BIAS_0$, $BIAS_1$ Input Current, High	I_{INH} , $BIAS_0$ or $BIAS_1$	$BIAS_0$, $BIAS_1 = 6V$	100	175	250	μA
$BIAS_0$, $BIAS_1$ Input Current, Low	I_{INL} , $BIAS_0$ or $BIAS_1$	$BIAS_0$, $BIAS_1 = 0V$	-5		+5	μA
$BIAS_0$, $BIAS_1$ Input Voltage, High	V_{INH} , $BIAS_0$ or $BIAS_1$		2.0			V
$BIAS_0$, $BIAS_1$ Input Voltage, Low	V_{INL} , $BIAS_0$ or $BIAS_1$				0.8	V

3. Typical Performance Curves

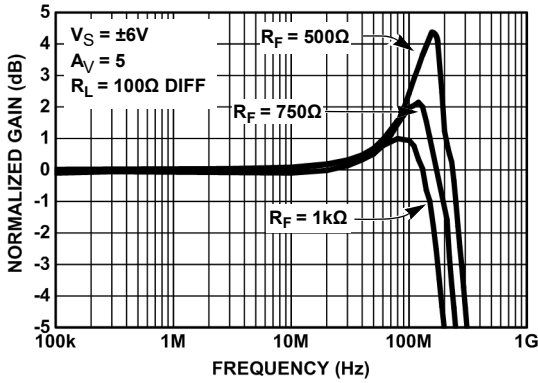


Figure 1. Differential Frequency Response with Various R_F (Full Bias Mode)

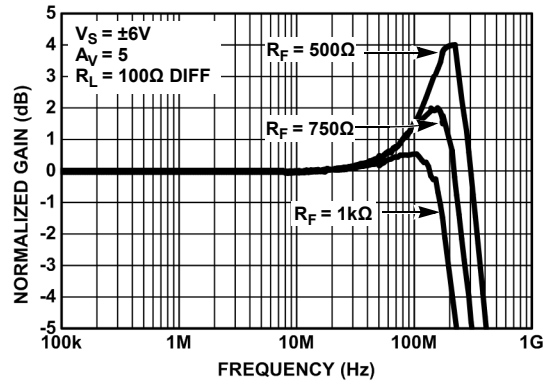


Figure 2. Differential Frequency Response with Various R_F (Medium Bias Mode)

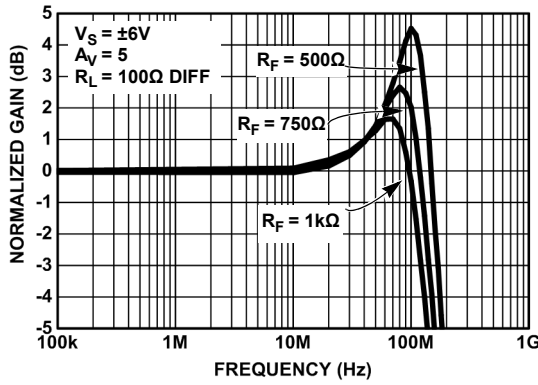


Figure 3. Differential Frequency Response with Various R_F (Low Bias Mode)

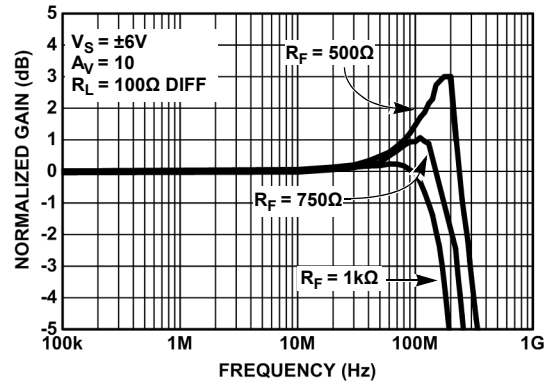


Figure 4. Differential Frequency Response with Various R_F (Full Bias Mode)

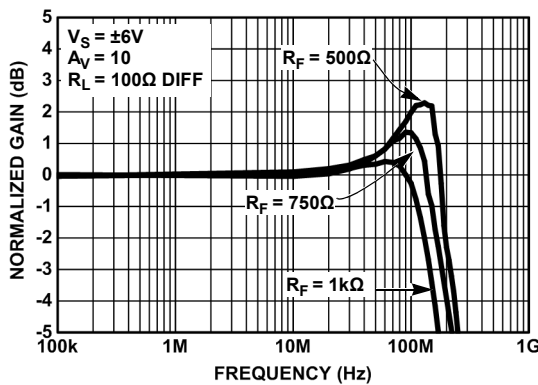


Figure 5. Differential Frequency Response with Various R_F (Medium Bias Mode)

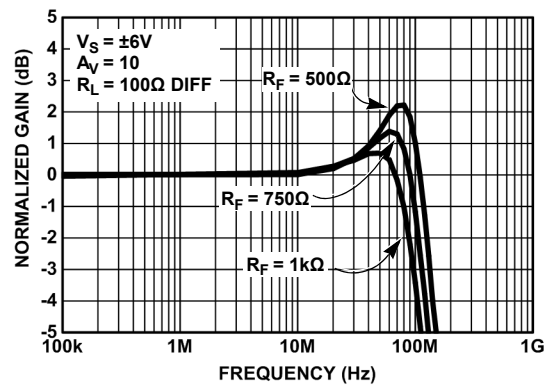


Figure 6. Differential Frequency Response with Various R_F (Low Bias Mode)

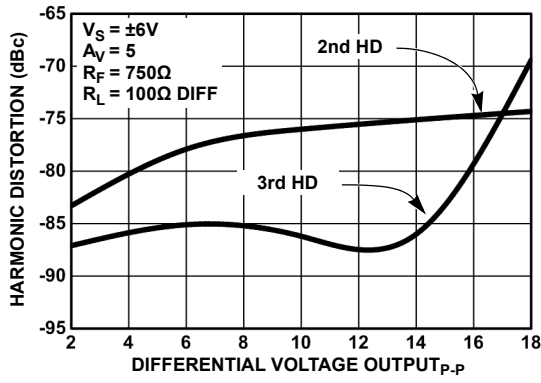


Figure 7. Harmonic Distortion at 2MHz

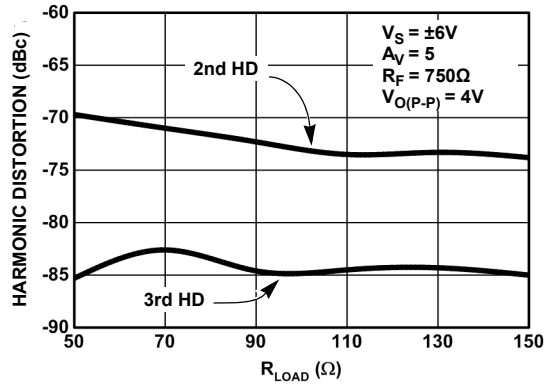


Figure 8. 2nd and 3rd Harmonic Distortion vs R_{LOAD} at 2MHz

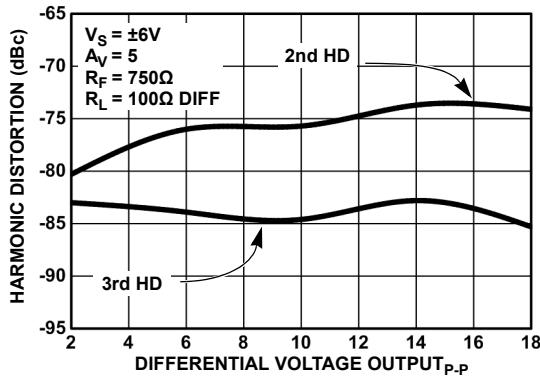


Figure 9. Harmonic Distortion at 3MHz

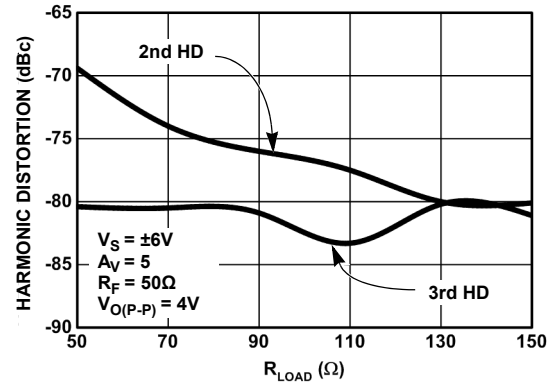


Figure 10. 2nd and 3rd Harmonic Distortion vs R_{LOAD} at 3MHz

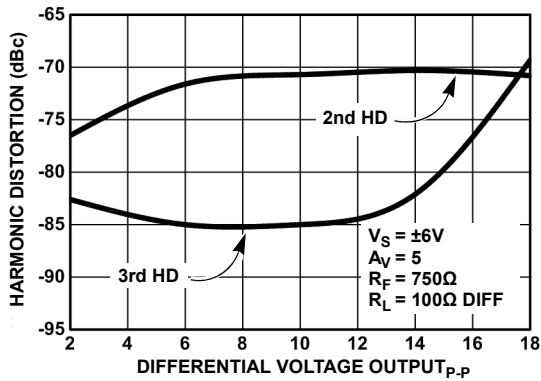


Figure 11. Harmonic Distortion at 5MHz

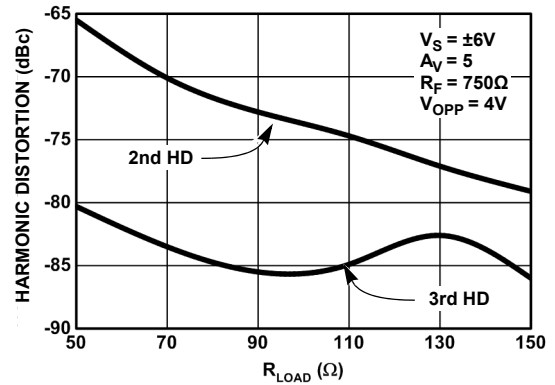


Figure 12. 2nd and 3rd Harmonic Distortion vs R_{LOAD} at 5MHz

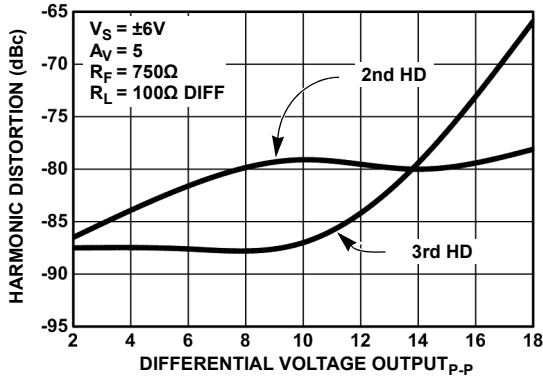


Figure 13. Harmonic Distortion at 10MHz

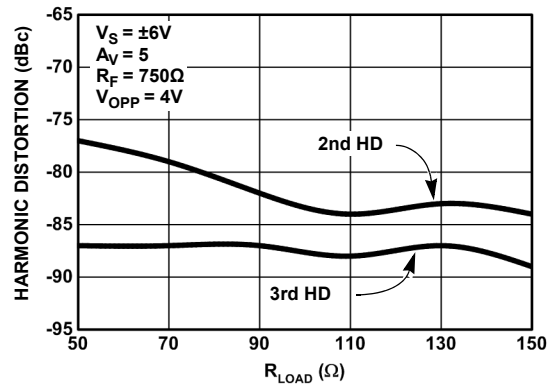


Figure 14. 2nd and 3rd Harmonic Distortion vs R_{LOAD} at 10MHz

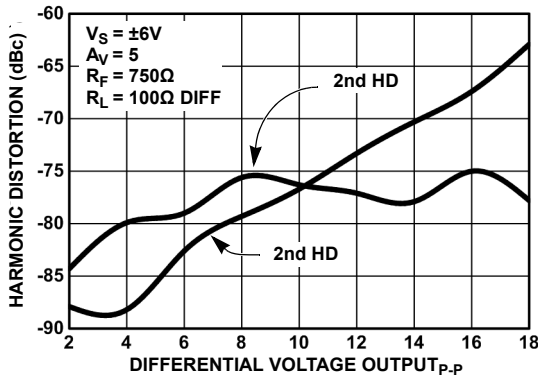


Figure 15. Harmonic Distortion at 17MHz

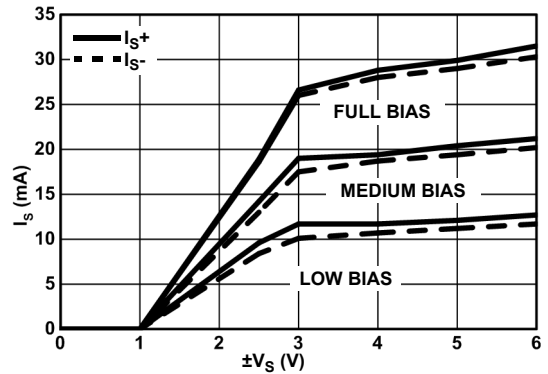


Figure 16. Supply Current vs Supply Voltage

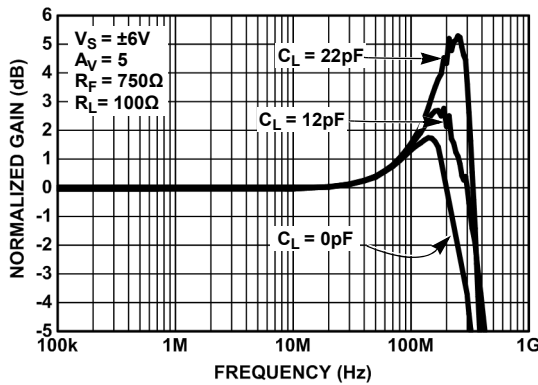


Figure 17. Frequency Response with Various C_L (Full Bias Mode)

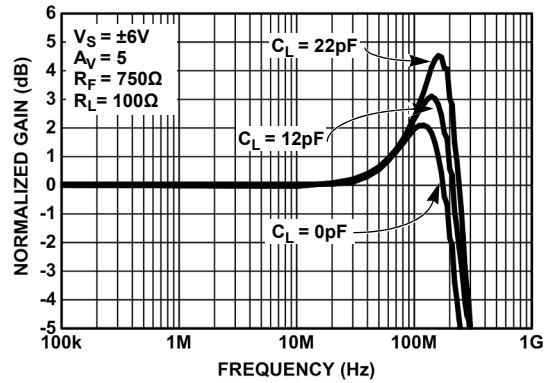


Figure 18. Frequency Response vs Various C_L (Medium Bias Mode)

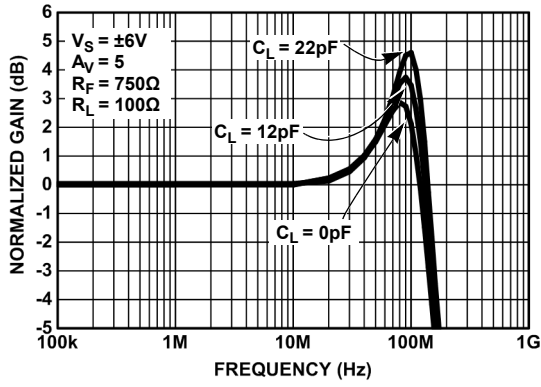


Figure 19. Frequency Response with Various C_L (Low Bias Mode)

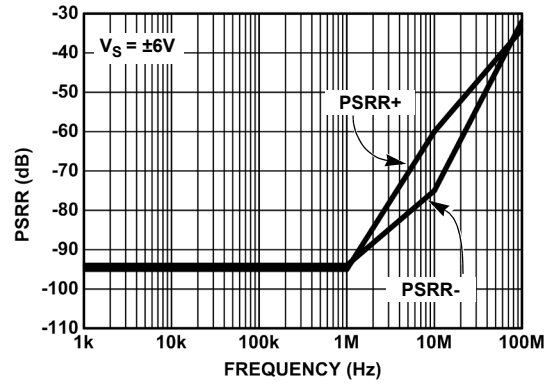


Figure 20. PSRR vs Frequency

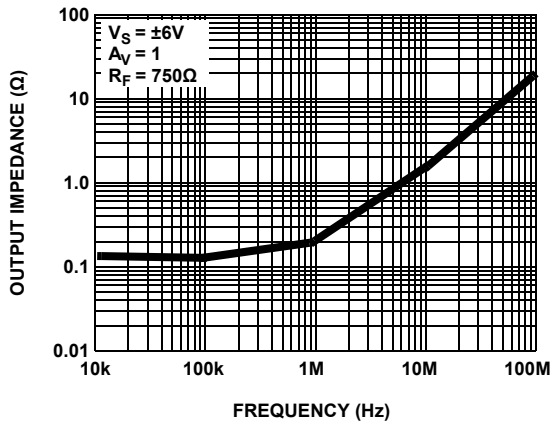


Figure 21. Output Impedance vs Frequency

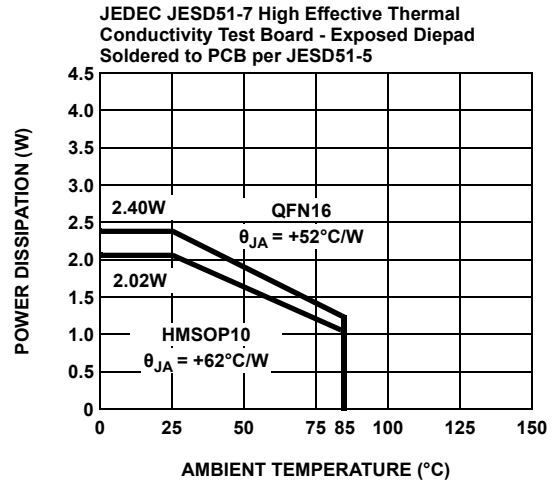


Figure 22. Package Power Dissipation vs Ambient Temperature

4. Product Description

The ISL1571 is a dual operational amplifier designed for line driving in OFDM and PLC solutions. It is a dual current-mode feedback amplifier with low distortion while drawing moderately low supply current. It is built using the Renesas proprietary complimentary bipolar process and is offered in industry standard pin configurations. Due to the current feedback architecture, the ISL1571 closed-loop 3dB bandwidth is dependent on the value of the feedback resistor. First the desired bandwidth is selected by choosing the feedback resistor, R_F , and then the gain is set by picking the gain resistor, R_G . The curves at the beginning of the [“Typical Performance Curves” on page 5](#), show the effect of varying both R_F and R_G . The 3dB bandwidth is somewhat dependent on the power supply voltage.

4.1 Power Supply Bypassing and Printed Circuit Board Layout

As with any high frequency device, good printed circuit board layout is necessary for optimum performance. Ground plane construction is highly recommended. Lead lengths should be as short as possible, below 0.25". The power supply pins must be well bypassed to reduce the risk of oscillation. A 4.7 μ F tantalum capacitor in parallel with a 0.1 μ F ceramic capacitor is adequate for each supply pin. During power-up, it is necessary to limit the slew rate of the rising power supply to within 1V/ μ s. If the power supply rising time is undetermined, a series 10 Ω resistor on the power supply line can be used to ensure the proper power supply rise time.

For good AC performance, parasitic capacitances is kept to a minimum, especially at the inverting input. This implies keeping the ground plane away from this pin. Carbon resistors are acceptable, while use of wire-wound resistors should be avoided because of their parasitic inductance. Similarly, capacitors should be low inductance for best performance.

4.2 Capacitance at the Inverting Input

Due to the topology of the current feedback amplifier, stray capacitance at the inverting input affects the AC and transient performance of the ISL1571 when operating in the non-inverting configuration.

In the inverting gain mode, added capacitance at the inverting input has little effect since this point is at a virtual ground and stray capacitance is therefore not “seen” by the amplifier.

4.3 Feedback Resistor Values

The ISL1571 has been designed and specified with $R_F = 750\Omega$ for $A_V = +5$. This value of feedback resistor yields extremely flat frequency response with 1dB peaking out to 250MHz. As is the case with all current feedback amplifiers, wider bandwidth, at the expense of slight peaking, can be obtained by reducing the value of the feedback resistor. Inversely, larger values of feedback resistor causes rolloff to occur at a lower frequency. See the curves in the [Typical Performance Curves](#) beginning on [page 5](#), which show 3dB bandwidth and peaking versus frequency for various feedback resistors and various supply voltages.

4.4 Bandwidth vs Temperature

Whereas many amplifier's supply current (and consequently 3dB bandwidth) drop off at high temperature, the ISL1571 was designed to have little supply current variations with temperature. An immediate benefit is the 3dB bandwidth does not drop off drastically with temperature.

4.5 Supply Voltage Range

The ISL1571IRZ has been designed to operate with supply voltages from $\pm 2.25V$ to $\pm 6V$ nominal. Optimum bandwidth, slew rate, and video characteristics are obtained at higher supply voltages.

4.6 Single Supply Operation

If a single supply is desired, values from +4.5V to +12V nominal can be used as long as the input common-mode range is not exceeded. When using a single supply, be sure to either:

1. DC bias the inputs at an appropriate common-mode voltage and AC couple the signal, or:
2. Ensure the driving signal is within the common-mode range of the ISL1571. ISL1571UEZ must be used in single supply applications.

4.7 PLC Modem Applications

The ISL1571 is designed as a line driver for PLC modems. It is capable of outputting 450mA of output current with a typical supply voltage headroom of 1.3V. It can achieve -85dBc of distortion at low 7.1mA of supply current per amplifier.

The average line power requirement for the PLC application is 13dBm (20mW) into a 100Ω line. The average line voltage is 1.41V_{RMS}. Using a differential drive configuration and transformer coupling with standard back termination, a transformer ratio of 1:2 is selected. The circuit configuration is shown in [Figure 23](#).

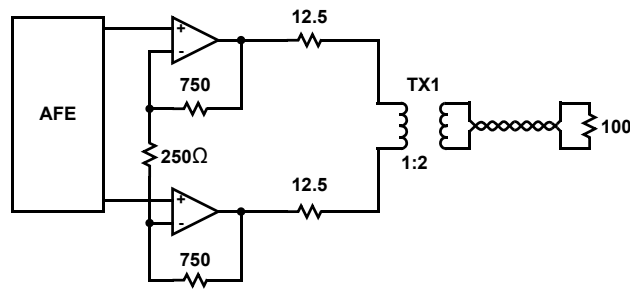


Figure 23. Circuit Configuration

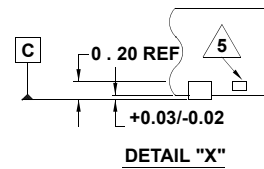
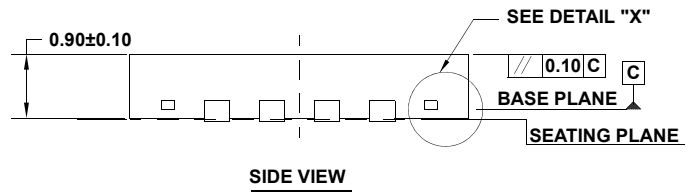
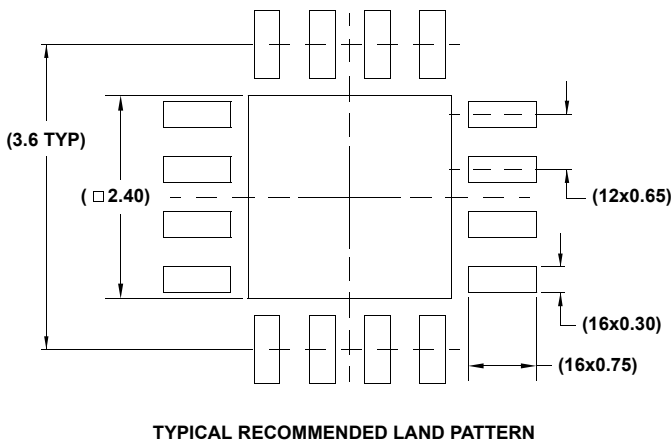
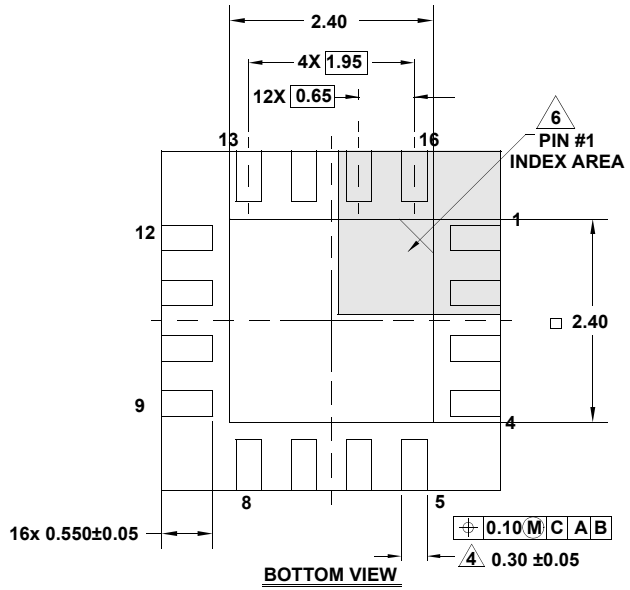
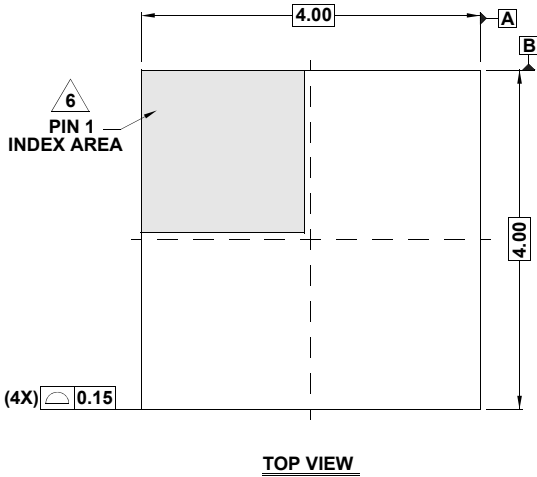
5. Revision History

Rev.	Date	Description
3.00	Nov.7.19	Changed POD MDP0050 to POD M10.118B in the ordering information table and in the Package Outline Drawings section.
2.00	Jun.14.19	Applied new formatting throughout. Updated Ordering Information table: Added Tape and Reel quantity column, added MSL note Electrical Specifications table, Supply section: Positive Supply Current per Amplifier, Test Conditions - added " $V_S = 4.5V$, no load," POD MDP0046: Replaced POD MDP0046 with L16.4x4H. Updated disclaimer.

6. Package Outline Drawings

For the most recent package outline drawing, see [L16.4x4H](#).

L16.4x4H
 16 Lead Quad Flat No-Lead Plastic Package
 Rev 0, 1/12

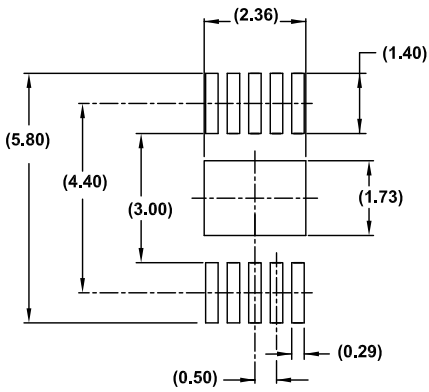
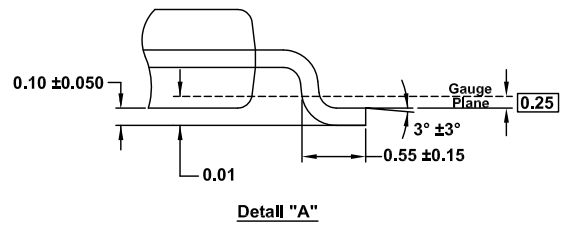
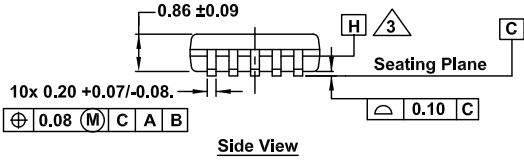
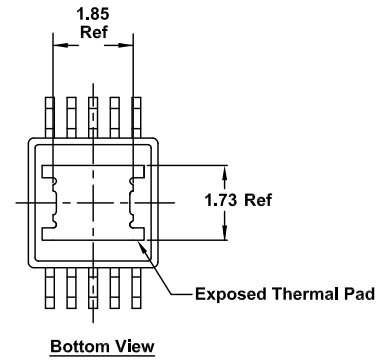
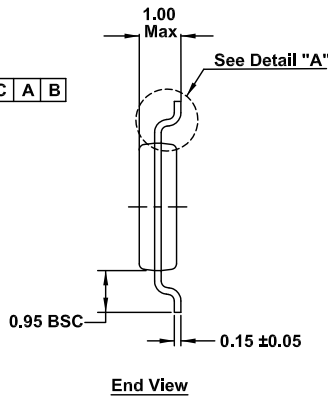
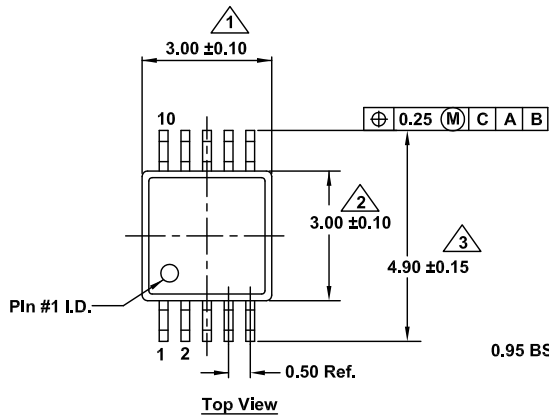


NOTES:

1. Dimensions are in millimeters.
Dimensions in () for Reference Only.
2. Dimensioning and tolerancing conform to ASME Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal ± 0.05
4. Dimension applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
5. Tiebar shown (if present) is a non-functional feature.
6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.

M10.118B
 10 Lead Heatsink Mini Small Outline Plastic Package (HMSOP, Heatsink MSOP)
 Rev 2, 10/19

For the most recent package outline drawing, see [M10.118B](#).



Notes:

- ① Plastic or metal protrusions of 0.15 maximum per side are not included.
- ② Plastic interlead protrusions of 0.25 maximum per side are not included.
- ③ Package body length and width dimensions are measured at Datum Plane "H".
- 4. Dimensioning and tolerancing conform to ASME Y14.5M-1994.
- 5. Dimensions are in millimeters.
 Dimensions in () for reference only.

Notice

1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation or any other use of the circuits, software, and information in the design of your product or system. Renesas Electronics disclaims any and all liability for any losses and damages incurred by you or third parties arising from the use of these circuits, software, or information.
2. Renesas Electronics hereby expressly disclaims any warranties against and liability for infringement or any other claims involving patents, copyrights, or other intellectual property rights of third parties, by or arising from the use of Renesas Electronics products or technical information described in this document, including but not limited to, the product data, drawings, charts, programs, algorithms, and application examples.
3. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
4. You shall not alter, modify, copy, or reverse engineer any Renesas Electronics product, whether in whole or in part. Renesas Electronics disclaims any and all liability for any losses or damages incurred by you or third parties arising from such alteration, modification, copying or reverse engineering.
5. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The intended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.
 - "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; industrial robots; etc.
 - "High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control (traffic lights); large-scale communication equipment; key financial terminal systems; safety control equipment; etc.Unless expressly designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not intended or authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems; surgical implantations; etc.), or may cause serious property damage (space system; undersea repeaters; nuclear power control systems; aircraft control systems; key plant systems; military equipment; etc.). Renesas Electronics disclaims any and all liability for any damages or losses incurred by you or any third parties arising from the use of any Renesas Electronics product that is inconsistent with any Renesas Electronics data sheet, user's manual or other Renesas Electronics document.
6. When using Renesas Electronics products, refer to the latest product information (data sheets, user's manuals, application notes, "General Notes for Handling and Using Semiconductor Devices" in the reliability handbook, etc.), and ensure that usage conditions are within the ranges specified by Renesas Electronics with respect to maximum ratings, operating power supply voltage range, heat dissipation characteristics, installation, etc. Renesas Electronics disclaims any and all liability for any malfunctions, failure or accident arising out of the use of Renesas Electronics products outside of such specified ranges.
7. Although Renesas Electronics endeavors to improve the quality and reliability of Renesas Electronics products, semiconductor products have specific characteristics, such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Unless designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not subject to radiation resistance design. You are responsible for implementing safety measures to guard against the possibility of bodily injury, injury or damage caused by fire, and/or danger to the public in the event of a failure or malfunction of Renesas Electronics products, such as safety design for hardware and software, including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult and impractical, you are responsible for evaluating the safety of the final products or systems manufactured by you.
8. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. You are responsible for carefully and sufficiently investigating applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive, and using Renesas Electronics products in compliance with all these applicable laws and regulations. Renesas Electronics disclaims any and all liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
9. Renesas Electronics products and technologies shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You shall comply with any applicable export control laws and regulations promulgated and administered by the governments of any countries asserting jurisdiction over the parties or transactions.
10. It is the responsibility of the buyer or distributor of Renesas Electronics products, or any other party who distributes, disposes of, or otherwise sells or transfers the product to a third party, to notify such third party in advance of the contents and conditions set forth in this document.
11. This document shall not be reprinted, reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics.
12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products.

(Note1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its directly or indirectly controlled subsidiaries.

(Note2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

(Rev.4.0-1 November 2017)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,
Koto-ku, Tokyo 135-0061, Japan
www.renesas.com

Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit:
www.renesas.com/contact/

Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.